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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/665,882	09/19/2003	Darrell Rinerson	UNTYP027	6771	
42958	7590 06/08/2005		EXAMINER		
UNITY SEMICONDUCTOR CORPORATION 250 NORTH WOLFE ROAD SUNNYVALE, CA 94085			ECKERT II, GEORGE C		
			ART UNIT	PAPER NUMBER	
			2815		
			DATE MAILED: 06/08/2005		

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)			
Office Action Summary		10/665,882	RINERSON ET AL.			
		Examiner	Art Unit			
		George C. Eckert II	2815			
Period fo	The MAILING DATE of this communication apport Reply	pears on the cover sheet with the c	orrespondence address			
THE - Exte after - If the - If NC - Failu Any	ORTENED STATUTORY PERIOD FOR REPL MAILING DATE OF THIS COMMUNICATION. nsions of time may be available under the provisions of 37 CFR 1.1 SIX (6) MONTHS from the mailing date of this communication. e period for reply specified above is less than thirty (30) days, a repl period for reply is specified above, the maximum statutory period or to reply within the set or extended period for reply will, by statute reply received by the Office later than three months after the mailing ed patent term adjustment. See 37 CFR 1.704(b).	I36(a). In no event, however, may a reply be timely within the statutory minimum of thirty (30) days will apply and will expire SIX (6) MONTHS from a cause the application to become ABANDONE	nely filed s will be considered timely. the mailing date of this communication. D (35 U.S.C.§ 133).			
Status						
1) 🏹	Responsive to communication(s) filed on 24 M	Narch 2005.				
•		s action is non-final.				
3)□	Since this application is in condition for allowance except for formal matters, prosecution as to the ments is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.					
Disposit	ion of Claims					
5)□ 6)⊠ 7)□	Claim(s) 1-31 is/are pending in the application 4a) Of the above claim(s) is/are withdra Claim(s) is/are allowed. Claim(s) 1-31 is/are rejected. Claim(s) is/are objected to. Claim(s) are subject to restriction and/or	wn from consideration.				
Applicat	ion Papers					
10)⊠	The specification is objected to by the Examine The drawing(s) filed on <u>19 September 2003</u> is/Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct The oath or declaration is objected to by the Examine The September 2003 is/Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct The Oath or declaration is objected to by the Examine The September 2003 is/Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct may not request that any objection to the Replacement drawing sheet(s) including the correct may not request that any objection to the Replacement drawing sheet(s) including the correct may not request that any objection to the Replacement drawing sheet(s) including the correct may not request that any objection to the Replacement drawing sheet(s) including the correct may not request that any objection to the Replacement drawing sheet(s) including the correct may not request that any objection to the Replacement drawing sheet(s) including the correct may not request the objection to the Replacement drawing sheet(s) including the correct may not request the objection to the Replacement drawing sheet(s) including the correct may not request the objection to the Replacement drawing sheet(s) including the correct may not request the objection to the Replacement drawing sheet may not request the objection to the Replacement drawing sheet may not request the request that the request the request that the request the request that the reque	are: a) accepted or b) object drawing(s) be held in abeyance. See tion is required if the drawing(s) is ob	e 37 CFR 1.85(a). jected to. See 37 CFR 1.121(d).			
Priority (under 35 U.S.C. § 119					
a)	Acknowledgment is made of a claim for foreign All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority application from the International Burea See the attached detailed Office action for a list	ts have been received. ts have been received in Applicationity documents have been receive nu (PCT Rule 17.2(a)).	on No ed in this National Stage			
2) Notice 3) Infor	ot(s) ce of References Cited (PTO-892) ce of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO-1449 or PTO/SB/08) er No(s)/Mail Date	4) M Interview Summary Paper No(s)/Mail Do 5) Motice of Informal F 6) Other:	(PTO-413) ate. <u>3/30/05</u> Patent Application (PTO-152)			

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DETAILED ACTION

Response to Amendment

1. Applicant's amendment dated March 24, 2005 in which claims 1, 4 and 24 were amended and claims 28-31 added has been entered.

Claim Objections

2. The previous objections to claims 4, 22 (the second 22) and 24 are overcome by applicant's amendment.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (a) the invention was known or used by others in this country, or patented or described in a printed publication in this or a foreign country, before the invention thereof by the applicant for a patent.
- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 3. Claims 1-27 are rejected under 35 U.S.C. 102(b) as being anticipated by Liu et al. (6,204,139, of record). Liu et al. teach in figure 1 a resistive memory device comprising:
 - a conductive bottom electrode 10;
- a multi-resistive state element 14 arranged on top of and in contact with the bottom electrode 10 such that a bottom interface is created (by means of their proximity), the multi-resistive state element having a substantially crystalline layer that, while substantially maintaining its substantially crystalline structure has a modifiable resistance (the material used by Liu et al. is the perovskite PCMO (col. 3, lines 26-28) which is a crystalline material and changes its resistivity based on application of an electric field or current (col. 3, lines 44-45);

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note also that PCMO is the same material as described by applicant for use in the instant invention, spec. para. 0047; finally, note that Liu et al. teach that too high an electric field or current will destroy the crystal or microstructure of the perovskite (col. 3, lines 55-57) while the Liu et al. device is operated such that the resistance is changed without destruction of the crystal (col. 3, lines 58-63)); and

a conductive top electrode 15 arranged on top of and in contact with the multi-resistive state element such that a top interface is created (by its proximity);

wherein the resistance of the memory device may be changed by applying a first voltage having a first polarity across the conductive electrodes and reversibly changed by applying a second voltage with a second polarity across the conductive electrodes (col. 4, lines 18-22); and

wherein at least one of the interfaces is subjected to a treatment directed towards changing properties of the at least one interface (col. 5, lines 12-23).

Regarding claims 2-26, these claims are drawn to a method by which the interface treatment is performed. First, because Liu et al. already teach that an interface is created between at least one electrode and the multi-resistive state element (col. 5, lines 20-23), it is immaterial in a product claim such as this how that interface was created since it is the final product that is considered for patentability. Furthermore, Liu et al. do teach several methods by which the interface may be treated when formed. For example, Liu et al. teach in column 4, lines 55-59 that the device is formed in an oxidizing environment during deposition which reads on the process of claim 5 ("exposure to a gas"). Therefore, the remaining claims are also considered anticipated by Liu et al.

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4. Claims 28-31 are rejected under 35 U.S.C. 102(a) as being anticipated by Reproducible

Electric-Pulse Induced Resistive (EPIR) Switch Effect of Manganite Films for Non-Volatile

Memory Applications to Liu et al. (the article itself is not dated but is here provided with the first

page of a presentation of the article Liu et al. made on 11/4/02. The presentation and article may

be found at

http://klabs.org/richcontent/MemoryContent/nvmt_symp/nvmts_2002/docs/26/26_ignatiev_s.pdf

and

http://klabs.org/richcontent/MemoryContent/nvmt_symp/nvmts_2002/docs/26/26_ignatiev_p.pdf respectively).

Liu et al. teach a resistive memory device comprising:

a conductive bottom electrode, substantially polycrystalline multi-resistive state element and a top electrode (Liu et al. teach under *PCMO FILM DEPOSITION*, that a layer of PCMO is deposited on a Pt lower electrode and teach under *RESISTANCE SWITCHING PROPERTIES OF PCMO FILMS*, that an Au upper electrode is formed on the PCMO and that the PCMO, which is a perovskite, is polycrystalline);

wherein the resistance of the memory device may be programmed by applying first and second voltages having different polities (see fig. 3); and

wherein at least one of the interfaces has been subjected to a treatment (see again *PCMO FILM DEPOSITION* where Liu et al. teach that the device is formed in an oxygen ambient which is considered a treatment that changes the device properties).

Response to Arguments

5. Applicant's arguments with respect to claims 1-27 have been considered but are moot in view of the new grounds of rejection.

Conclusion

6. Applicant's amendment necessitated the new grounds of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to George C. Eckert II whose telephone number is (571) 272-1728.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Tom Thomas can be reached on (571) 272-1664. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

GEORGE ECKERT
PRIMARY EXAMINER